

# DS8921/DS8921A/DS8921AT Differential Line Driver and Receiver Pair

#### **General Description**

The DS8921, DS8921A are Differential Line Driver and Receiver pairs designed specifically for applications meeting the ST506, ST412 and ESDI Disk Drive Standards. In addition, these devices meet the requirements of the EIA Standard RS-422.

The DS8921, DS8921A receivers offer an input sensitivity of 200 mV over a ±7V common mode operating range. Hysteresis is incorporated (typically 70 mV) to improve noise margin for slowly changing input waveforms.

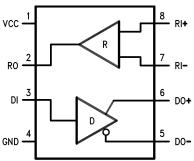
The DS8921, DS8921A drivers are designed to provide unipolar differential drive to twisted pair or parallel wire transmission lines. Complementary outputs are logically ANDed and provide an output skew of 0.5 ns (typ.) with propagation delays of 12 ns.

The DS8921, DS8921A are designed to be compatible with TTL and CMOS.

#### **Features**

- 12 ns typical propagation delay
- Output skew 0.5 ns typical
- Meet the requirements of EIA Standard RS-422
- Complementary Driver Outputs
- High differential or common-mode input voltage ranges of ±7V
- ±0.2V receiver sensitivity over the input voltage range
- Receiver input hysteresis-70 mV typical
- DS8921AT industrial temperature operation: (-40°C to +85°C)

#### **Connection Diagram**



00851201

Order Number DS8921M, DS8921N, DS8921AM, DS8921AN, DS8921ATM, or DS8921ATN

See NS Package Number M08A or N08E

#### **Truth Table**

Receiver	Driver			
Input	V <sub>OUT</sub>	Input	V <sub>out</sub>	$\overline{V_{OUT}}$
$V_{ID} \ge V_{TH} \text{ (MAX)}$	1	1	1	0
$V_{ID} \le V_{TH} (MIN)$	0	0	0	1
Open	1			

## **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage 7V
Driver Input Voltage -0.5V to +7V
Output Voltage 5.5V

Receiver Output Sink

Current 50 mA
Receiver Input Voltage ±10V
Differential Input Voltage ±12V
Maximum Package Power Dissipation @ +25°C

M Package 730 mW N Package 1160 mW

Derate M Package 9.3 mW/ $^{\circ}$ C above +25 $^{\circ}$ C

Derate N Package 5.8 mW/ $^{\circ}$ C above +25 $^{\circ}$ C

Storage Temperature

Range  $-65^{\circ}\text{C}$  to  $+165^{\circ}\text{C}$ Lead Temperature  $+260^{\circ}\text{C}$ (Soldering, 4 sec.)  $+260^{\circ}\text{C}$ 

Maximum Junction

Temperature +150°C

# Recommended Operating Conditions

	Min	Max	Units
Supply Voltage	4.5	5.5	V
Temperature (T <sub>A</sub> )			
DS8921/DS8921A	0	70	°C
DS8921AT	-40	+85	°C

#### DS8921/DS8921A Electrical Characteristics (Notes 2, 3, 4)

Symbol	Conditions	Min	Тур	Max	Units
RECEIVER		•			
V <sub>TH</sub>	$-7V \le V_{CM} \le +7V$	-200	±35	+200	mV
V <sub>HYST</sub>	$-7V \le V_{CM} \le +7V$	15	70		mV
R <sub>IN</sub>	$V_{IN} = -7V, +7V$	4.0	6.0		kΩ
	(Other Input = GND)				
I <sub>IN</sub>	V <sub>IN</sub> = 10V			3.25	mA
	$V_{IN} = -10V$			-3.25	mA
V <sub>OH</sub>	I <sub>OH</sub> = -400 μA	2.5			V
V <sub>OL</sub>	I <sub>OL</sub> = 8 mA			0.5	V
I <sub>sc</sub>	$V_{CC} = MAX, V_{OUT} = 0V$	-15		-100	mA
DRIVER	·				
V <sub>IH</sub>		2.0			V
V <sub>IL</sub>				0.8	V
I <sub>IL</sub>	$V_{CC} = MAX, V_{IN} = 0.4V$		-40	-200	μΑ
I <sub>IH</sub>	$V_{CC} = MAX, V_{IN} = 2.7V$			20	μΑ
I <sub>I</sub> V <sub>CL</sub>	$V_{CC} = MAX, V_{IN} = 7.0V$			100	μΑ
$V_{CL}$	$V_{CC} = MIN, I_{IN} = -18 \text{ mA}$			-1.5	V
V <sub>OH</sub>	$V_{CC} = MIN, I_{OH} = -20 \text{ mA}$	2.5			V
V <sub>OL</sub>	$V_{CC} = MIN, I_{OL} = +20 \text{ mA}$			0.5	V
l <sub>OFF</sub>	$V_{CC} = 0V, V_{OUT} = 5.5V$			100	μΑ
$ V_T  -  \overline{VT} $				0.4	V
V <sub>T</sub>		2.0			V
IV <sub>OS</sub> - V <sub>OS</sub> I				0.4	V
I <sub>sc</sub>	V <sub>CC</sub> = MAX, V <sub>OUT</sub> = 0V	-30		-150	mA
DRIVER and RECEI	VER				
I <sub>cc</sub>	$V_{CC} = MAX, V_{OUT} = Logic 0$			35	mA

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## **Receiver Switching Characteristics**

Figure 1(Figure 2)

Symbol	Conditions	Min	Тур	Max			Units
				8921	8921A	8921AT	
T <sub>pLH</sub>	C <sub>L</sub> = 30 pF		14	22.5	20	20	ns
	$C_L = 30 \text{ pF}$ (Figures 1, 2)						
T <sub>pHL</sub>	C <sub>L</sub> = 30 pF		14	22.5	20	20	ns
	$C_L = 30 \text{ pF}$ (Figures 1, 2)						
IT <sub>pLH</sub> -T <sub>pHL</sub> I	C <sub>L</sub> = 30 pF		0.5	5	3.5	5	ns
	$C_L = 30 \text{ pF}$ (Figures 1, 2)						

# **Driver Switching Characteristics**

**SINGLE ENDED CHARACTERISTICS** (Figures 3, 4)

Symbol	Conditions	Min	Тур		Units		
				8921	8921A	8921AT	]
T <sub>pLH</sub>	C <sub>L</sub> = 30 pF		10	15	15	15	ns
	(Figures 3, 4)						
T <sub>pHL</sub>	C <sub>L</sub> = 30 pF		10	15	15	15	ns
	(Figures 3, 4)						
T <sub>TLH</sub>	C <sub>L</sub> = 30 pF		5	8	8	9.5	ns
	(Figures 7, 8)						
T <sub>THL</sub>	C <sub>L</sub> = 30 pF		5	8	8	9.5	ns
	(Figures 7, 8)						
Skew	CL = 30 pF		1	5	3.5	3.5	ns
	(Figures 3, 4)						

# **Driver Switching Characteristics**(Note 6)

**DIFFERENTIAL CHARACTERISTICS** (Figures 3, 5)

Symbol	Conditions	Min	Тур	Max			Units
				8921	8921A	8921AT	
T <sub>pLH</sub>	C <sub>L</sub> = 30 pF		10	15	15	15	ns
	C <sub>L</sub> = 30 pF ( <i>Figures 3, 5, 6</i> )						
T <sub>pHL</sub>	C <sub>L</sub> = 30 pF ( <i>Figures 3, 5, 6</i> )		10	15	15	15	ns
	(Figures 3, 5, 6)						
IT <sub>pLH</sub> -T <sub>pHL</sub> I	C <sub>L</sub> = 30 pF ( <i>Figures 3, 5, 6</i> )		0.5	6	2.75	2.75	ns
	(Figures 3, 5, 6)						

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The Table of "Electrical Characteristics" provides conditions for actual device operation.

**Note 2:** All currents into device pins are shown as positive values; all currents out of the device are shown as negative; all voltages are referenced to ground unless otherwise specified. All values shown as max or min are classified on absolute value basis.

Note 3: All typical values are  $V_{CC} = 5V$ ,  $T_A = 25^{\circ}C$ .

Note 4: Only one output at a time should be shorted.

Note 5: Difference between complementary outputs at the 50% point.

Note 6: Differential Delays are defined as calculated results from single ended rise and fall time measurements. This approach in establishing AC performance specifications has been taken due to limitations of available Automatic Test Equipment (ATE).

The calculated ATE results assume a linear transition between measurement points and are a result of the following equations:

$$T_{cr} = \frac{(T_{fb} \times T_{rb}) - (T_{ra} \times T_{fa})}{T_{rb} - T_{ra} - T_{fa} + T_{fb}}$$

Where: T<sub>cr</sub> = Crossing Point

 $T_{ra}, T_{rb}, T_{fa}$  and T  $_{fb}$  are time measurements with respect to the input. See Figure 6 .

# **AC Test Circuits and Switching Diagrams**

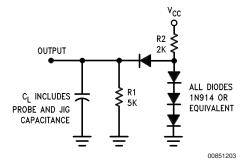


FIGURE 1.

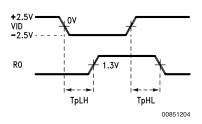


FIGURE 2.

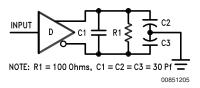


FIGURE 3.

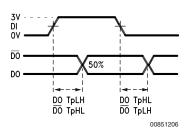


FIGURE 4.

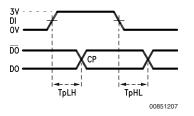


FIGURE 5.

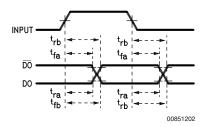


FIGURE 6.

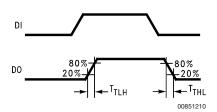


FIGURE 7.

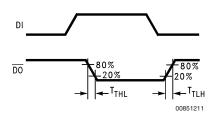
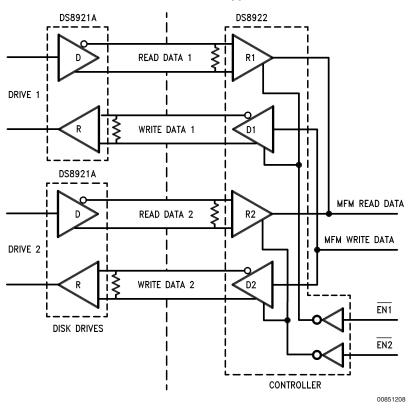


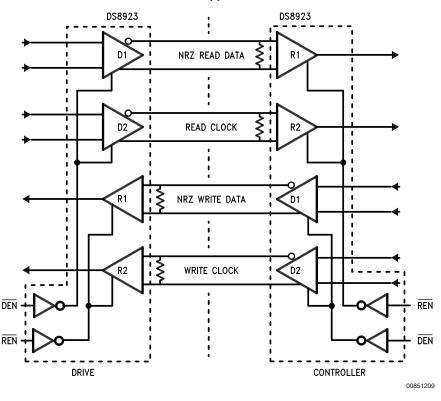
FIGURE 8.

# **Typical Applications**

#### ST506 and ST412 Application



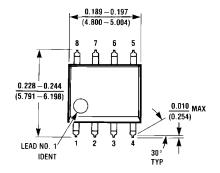
#### **ESDI Application**



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# Physical Dimensions inches (millimeters)

unless otherwise noted



0.008 TYP

(0.203)

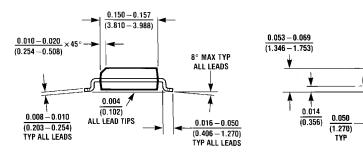
0.004 - 0.010

(0.102 - 0.254)

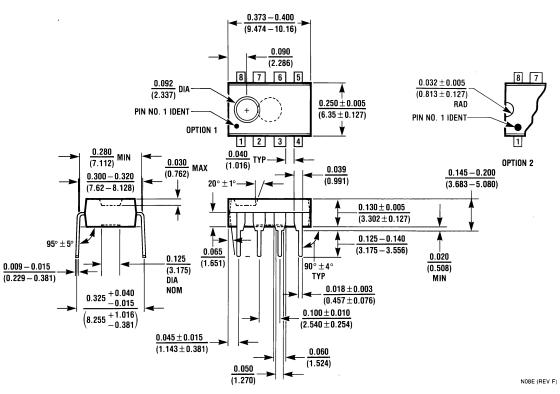
0.014 - 0.020 TYP

(0.356 - 0.508)

SEATING PLANE



SO Package (M)
Order Number DS8921M, DS8921ATM
NS Package Number M08A



Molded Dual-In-Line Package (N)
Order Number DS8921N, DS8921AN or DS8921ATN
NS Package Number N08E

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#### **Notes**

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